Unit: mm

TOSHIBA Insulated Gate Bipolar Transistor Silicon N Channel IGBT

## GT20J321

# High Power Switching Applications Fast Switching Applications

- Fourth-generation IGBT
- Enhancement mode type
- Fast switching (FS): Operating frequency up to 50 kHz (reference) High speed:  $t_f = 0.04 \mu s$  (typ.)

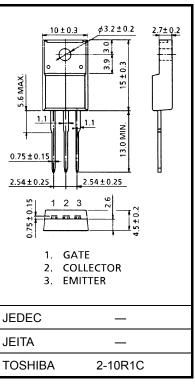
Low switching loss :  $E_{on} = 0.40 \text{ mJ (typ.)}$ 

 $: E_{off} = 0.43 \text{ mJ (typ.)}$ 

- Low saturation voltage: VCE (sat) = 2.0 V (typ.)
- FRD included between emitter and collector

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Collector-emitter voltage		V <sub>CES</sub>	600	V	
Gate-emitter voltage		$V_{GES}$	±20	V	
Collector current	DC	IC	20	Α	
	1 ms	I <sub>CP</sub>	40		
Emitter-collector forward current	DC	lF	20	Α	
	1 ms	I <sub>FM</sub>	40		
Collector power dissipation (Tc = 25°C)		PC	45	W	
Junction temperature		Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	−55 to 150	°C	



Weight: 1.7 g (typ.)

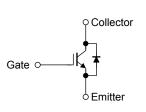
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

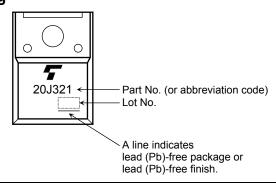
#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance (IGBT)	R <sub>th (j-c)</sub>	2.78	°C/W
Thermal resistance (diode)	R <sub>th (j-c)</sub>	4.23	°C/W

#### **Equivalent Circuit**



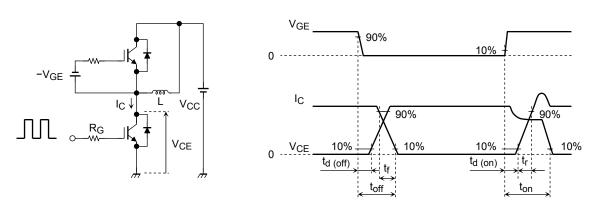
#### Marking



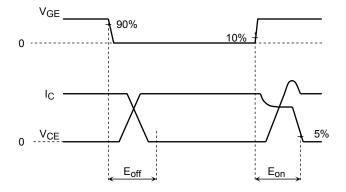
### Electrical Characteristics (Ta = 25°C)

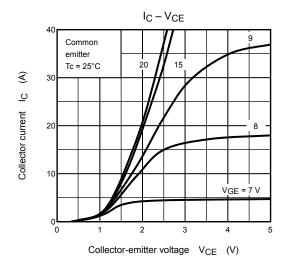
Cha	racteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I <sub>GES</sub>	V <sub>GE</sub> = ±20 V, V <sub>CE</sub> = 0	_	_	±500	nA
Collector cut-off	current	I <sub>CES</sub>	V <sub>CE</sub> = 600 V, V <sub>GE</sub> = 0	_	_	1.0	mA
Gate-emitter cut-off voltage		V <sub>GE</sub> (OFF)	I <sub>C</sub> = 2 mA, V <sub>CE</sub> = 5 V	3.5	_	6.5	V
Collector-emitter saturation voltage		V <sub>CE</sub> (sat)	I <sub>C</sub> = 20 A, V <sub>GE</sub> = 15 V	_	2.0	2.45	V
Input capacitance		C <sub>ies</sub>	V <sub>CE</sub> = 10 V, V <sub>GE</sub> = 0, f = 1 MHz	-	3000	_	pF
Switching time	Turn-on delay time	t <sub>d (on)</sub>	Inductive Load $V_{CC}=300 \text{ V, } I_{C}=20 \text{ A}$ $V_{GG}=+15 \text{ V, } R_{G}=33 \Omega$ (Note 1) (Note 2)	-	0.06	_	- μs
	Rise time	t <sub>r</sub>		_	0.04	_	
	Turn-on time	t <sub>on</sub>		_	0.17	_	
	Turn-off delay time	<sup>t</sup> d (off)		_	0.24	_	
	Fall time	t <sub>f</sub>		_	0.04	_	
	Turn-off time	t <sub>off</sub>		_	0.34	_	
Switching loss Tur	Turn-on switching loss	E <sub>on</sub>		_	0.40	_	- mJ
	Turn-off switching loss	E <sub>off</sub>		_	0.43	_	
Peak forward vo	oltage	V <sub>F</sub>	I <sub>F</sub> = 20 A, V <sub>GE</sub> = 0	_	_	2.1	٧
Reverse recovery time		t <sub>rr</sub>	I <sub>F</sub> = 20 A, di/dt = -100 A/μs	-	100	_	ns

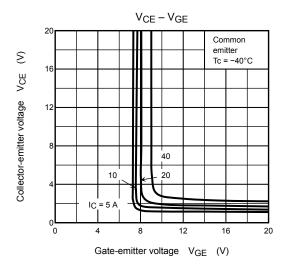
Note 1: Switching time measurement circuit and input/output waveforms

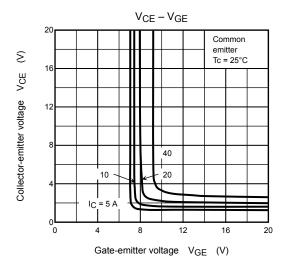


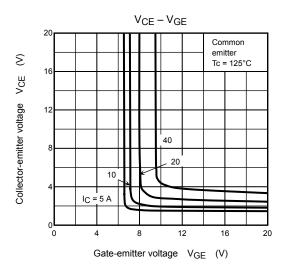
Note 2: Switching loss measurement waveforms

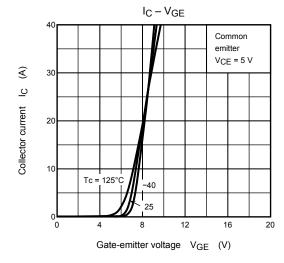


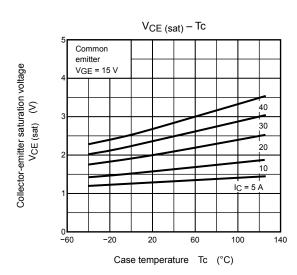




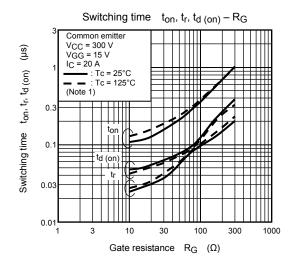


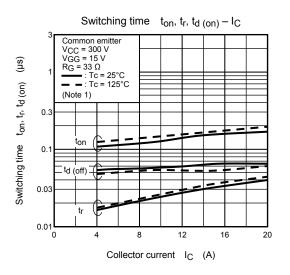


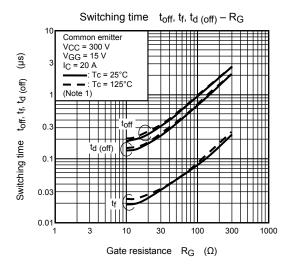


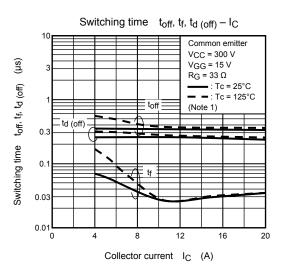


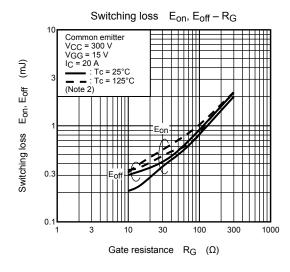
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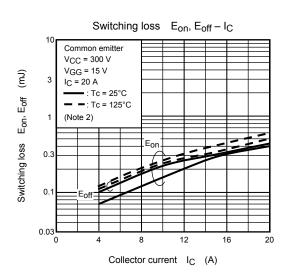


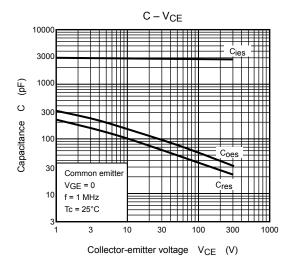


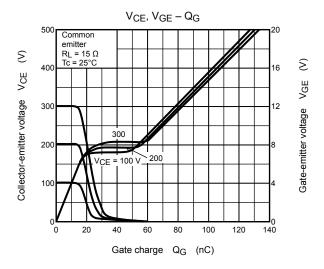


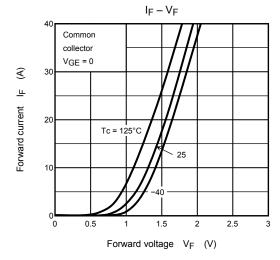


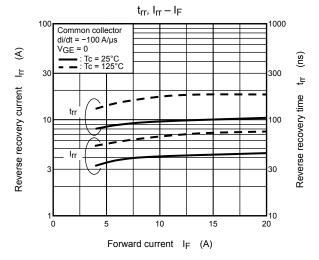


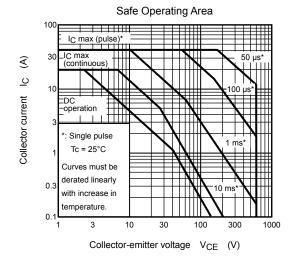


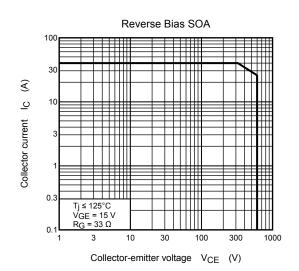


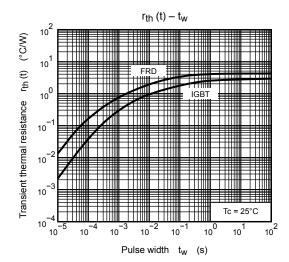












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